FDS6694

FAIRCHILD SEMICONDUCTOR

30V N-Channel Fast Switching PowerTrench^o MOSFET

General Description

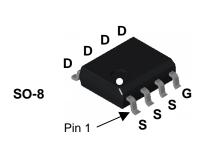
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

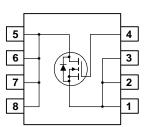
Applications

- DC/DC converter
- Power management
- Load switch

Features

- 12 A, 30 V. $R_{DS(ON)} = 11 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 13.5 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge (13 nC typical)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability.





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source	Voltage		30	V	
V _{GSS}	Gate-Source \	/oltage		±20	V	
ID	Drain Current	 Continuous 	(Note 1a)	12	A	
		- Pulsed		50		
P _D	Power Dissipa	tion for Single Operation	ON (Note 1a)	2.5	W	
			(Note 1b)	1.4		
			(Note 1c)	1.2		
T _J , T _{STG}	Operating and	Storage Junction Tem	perature Range	-55 to +175	°C	
Therma	I Characte	ristics				
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)		pient (Note 1a)	50	°C/W	
R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1c)		Dient (Note 1c)	125		
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)		e (Note 1)	25 °C/		
Packag	e Marking	and Ordering	Information			
	Marking	Device	Reel Size	Tape width	Quantity	
Device	Marking					

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FDS6694 Rev.E(W)

Off Char BV _{DSS}	Parameter	Test Conditions	Min	Тур	Max	Units
BV/acc	acteristics		•	•	•	•
D V DSS	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		22		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			10	μΑ
GSS	Gate–Body Leakage	$V_{GS}=\pm 20~V, ~~V_{DS}=0~V$			±100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	2	3	V
<u>ΔVGS(th)</u> ΔTJ	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			9.1 11.1 12.2	11 13.5 15	mΩ
D(on)	On-State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	50			Α
g FS	Forward Transconductance	$V_{DS} = 5 \text{ V}, \qquad I_D = 12 \text{ A}$		50		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance $V_{DS} = 15 V$, $V_{GS} = 0 V$,			1293		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		342		pF
C _{rss}	Reverse Transfer Capacitance			136		pF
R _G	Gate Resistance			0.84		Ω
Switchin	g Characteristics (Note 2)					
d(on)	Turn–On Delay Time	$V_{DD} = 15 V$, $I_D = -1 A$,		9	18	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		6	12	ns
d(off)	Turn–Off Delay Time			28	45	ns
ł	Turn–Off Fall Time			10	20	ns
Qg	Total Gate Charge	$V_{DS} = 15 \text{ V}, \qquad I_D = 12 \text{ A},$		13	19	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = 5 V$		4		nC
Q _{gd}	Gate–Drain Charge			4.7		nC
Drain–So	ource Diode Characteristics	and Maximum Ratings				
s	Maximum Continuous Drain-Source	Diode Forward Current			2.1	Α
	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.74	1.2	V
V _{SD}	Diode Reverse Recovery Time	$I_F = 12 \text{ A}, d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$		29		nS
V SD t _{rr}				30		nC

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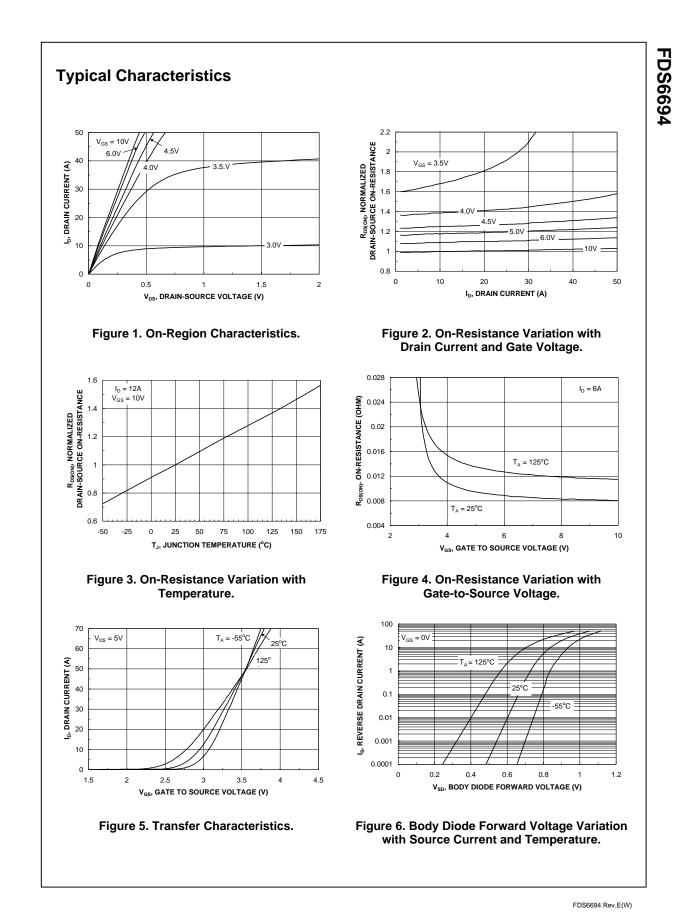
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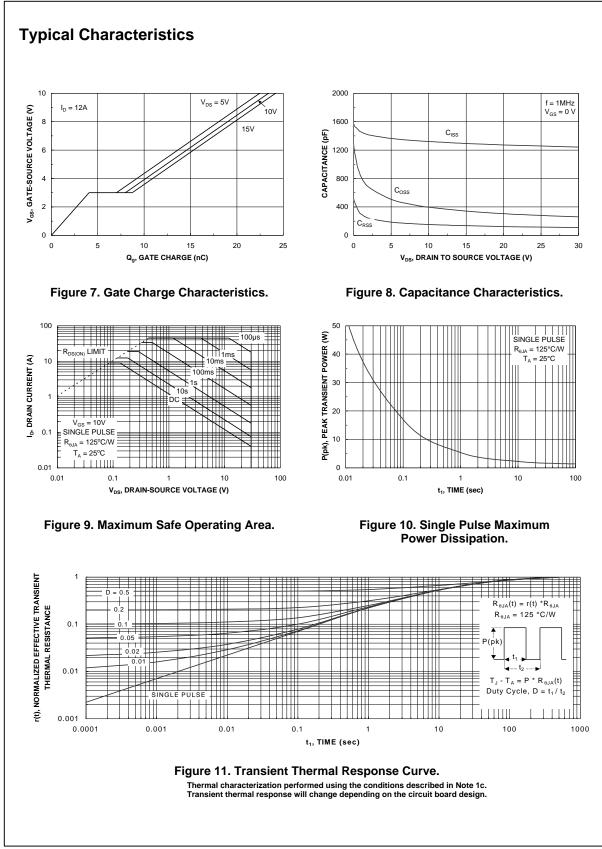
0000 Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDS6694 Rev.E(W)

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FDS6694

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